	· · · · · · · · · · · · · · · · · · ·	0.0000000000000000000000000000000000000	
FORM PTO-1449	Docket No.: I431.168.101	Serial No.: 10/588,927	
OLIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S	Applicant: Irwin Aberin et al.		
INTO PARENTS AND PUBLICATIONS FOR ATTEICANTS			
MAR 0~9 2007	Filing Date: August 9, 2006	Group Art:	

U.S. PATENT DOCUMENTS

PADEN			1			,	
Examiner Initial		Document No.	Date	Name	Class	Sub Class	Filing Date If Appropriate
/M.J./	AA	6,014,318	01/11/2000	Takeda		500050000000000	
/M.J	/ AB	6,054,755	04/25/2000	Takamichi et al.	30000000000000	5000000000000000	
/M.J.	AC	6,285,086	09/04/2001	Sota et al.	1000000000000000	200000000000000000000000000000000000000	
/M.J./	AD	2001/0042908	11/22/2001	Okada et al.	X0000000000000	5000000000000000	
/M.J./	AE	2002/0076858	06/20/2002	Dotta et al.	30000000000000	200000000000000	
	AF						
	AG						
	AH						
	ΑI						
	AJ				,		May A cas
	AK						
	AL						

FOREIGN PATENT DOCUMENTS

		Document No.	Date	Country	Class	Sub Class	Translated Yes No
/M.J./	AM	JP03283453	12/13/1991	Japan	xxxxxxxxxxxxx	***************************************	Yes (Abstract only)
/M.J./	AN	KR2002016126	03/04/2002	Korea	ю	300000000000000	Yes (Abstract only)
/M.J./	AO	KR2002064592	08/09/2002	Korea	55555550000000000000	***************************************	Yes (Abstract only)

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

/M.J./	AR		usion Modeling & Characterisation for El nce, 0-7803-7430-4/02/\$17.00 ©2002 IEE		Electronic				
/M.J./	AS	Wong et al., "The Mechanics and Impact of Hygroscopic Swelling of Polymeric Materials in Electronic Packaging", Electronic Components and Technology Conference, 0-7803-5911-9/00/\$10.00 (c)2000 IEEE							
	AT								
EXAMI	INER:	/Michael Jung/	DATE CONSIDERED:	04/13/2009					

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.